## Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:		CORRECTIVE ASSIGNMENT		
NATURE OF CONVEYANCE:		Application 61/412,755 filed Nov	Corrective Assignment to correct the Re-record to add U.S. Provisional Application 61/412,755 filed November 11, 2010 as priority information. previously recorded on Reel 026144 Frame 0687. Assignor(s) hereby confirms the Assignment.	
CONVEYING PART	Y DATA	/L		
Name			Execution Date	
Sergiu R. Goma			06/13/2011	
Milivoje Aleksic			06/12/2011	
Hau Hwang			06/13/2011	
Joseph Cheung			06/13/2011	
Name: Street Address:		QUALCOMM INCORPORATED		
City:	SAN DIEGO			
State/Country:	CALIFORNI	CALIFORNIA		
Postal Code:	92121			
	ERS Total: 1			
Property Type		Number		
Application Number:		13079640		
CORRESPONDENC	E DATA			
Fax Number: <i>Correspondence will</i> Email: Correspondent Nam Address Line 1: Address Line 4: ATTORNEY DOCKE	<i>I be sent via US</i> patent. e: QUALC 5775 M SAN D ET NUMBER:	58-2502 5 Mail when the fax attempt is unsuccessfu docketing.us@qualcomm.com COMM INCORPORATED IOREHOUSE DRIVE IEGO, CALIFORNIA 92121 101556 RICKI SIEGEL	<i>ul.</i>	
		IL	PATENT	
501566822 REFL: 026460 FRAME: 0396				

## **Total Attachments: 5**

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## ASSIGNMENT

WHEREAS, WE,

1. Sergiu R. Goma, a citizen of Canada, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, and a resident of San Diego, CA,

2. Milivoje Aleksic, a citizen of **Canada**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, and a resident of **San Diego**, **CA**,

3. Hau Hwang, a citizen of The United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, and a resident of San Diego, CA,

4. Joseph Cheung, a citizen of The United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, and a resident of San Diego, CA,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **COMBINING DATA FROM MULTIPLE IMAGE SENSORS** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 13/079,640 filed April 4, 2011, Qualcomm Reference No. 101556, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 61/324,259, filed April 14, 2010, Qualcomm Reference No. 101556P1, U.S. Provisional Application No(s). 61/324,259, filed April 14, 2010, Qualcomm Reference No. 101556P2, U.S. Provisional Application No(s). 61/359,312, filed June 28, 2010, Qualcomm Reference No. 101556P2, U.S. Provisional Application No(s). 61/412,755, filed November 11, 2010, Qualcomm Reference No. 101556P3, (and do hereby authorize

ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

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AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at Sau hego, on 6/13/2011 Correspondence Sau biego, on 6/13/2011 Correspondence Sergiu R. Goma

Done at Ste Die c.e., on 12/06/2011 Jilurye Aleunz LOCATION DATE Millivoje Aleksie

Done at See Prego, on 6/13/2011 14-2 1

Hau Hwang

Done at <u>Sun Dugo</u>, on <u>6/13/11</u> LOCATION DATE

Joseph Cheung

**RECORDED: 06/17/2011**